## Austin Lynx<sup>TM</sup>: SMT Non-Isolated DC-DC Power Modules, Programmable

3.0Vdc – 5.5Vdc input; 0.75Vdc to 3.63Vdc output; 10A Output Current

## **RoHS Compliant**



## **Applications**

- Distributed power architectures
- Intermediate bus voltage applications
- Telecommunications equipment
- Servers and storage applications
- Networking equipment
- Enterprise Networks
- Latest generation IC's (DSP, FPGA, ASIC) and Microprocessor powered applications

### Features

- Compliant to RoHS EU Directive 2011/65/EU (-Z versions)
- Compliant to RoHS EU Directive 2011/65/EU under exemption 7b (Lead solder exemption). Exemption 7b will expire after June 1, 2016 at which time this product will no longer be RoHS compliant (non-Z versions)
- Delivers up to 10A output current
- High efficiency 95% at 3.3V full load ( $V_{IN} = 5.0V$ )
- Small size and low profile:
  - 33.0 mm x 13.5 mm x 8.28 mm (1.30 in x 0.53 in x 0.326 in)
- Low output ripple and noise
- High Reliability:
  - Calculated MTBF = 15.7 M hours at 25°C Full-load
- Constant switching frequency (300 kHz)
- Output voltage programmable from 0.75 Vdc to 3.63Vdc via external resistor
- Line Regulation: 0.3% (typical)
- Load Regulation: 0.4% (typical)
- Temperature Regulation: 0.4 % (typical)
- Remote On/Off
- Remote Sense(optional)
- Over temperature protection
- Output overcurrent protection (non-latching)
- Wide operating temperature range (-40°C to 85°C)
- UL\* 60950-1Recognized, CSA<sup>†</sup> C22.2 No. 60950-1-03 Certified, and VDE<sup>‡</sup> 0805:2001-12 (EN60950-1) Licensed
- ISO\*\* 9001 and ISO 14001 certified manufacturing facilities

## Description

Austin Lynx<sup>™</sup> SMT (surface mount technology) power modules are non-isolated dc-dc converters that can deliver up to 10A of output current with full load efficiency of 95% at 3.3V output. These modules provide a precisely regulated output voltage programmable via an external resistor from 0.75Vdc to 3.63Vdc over a wide range of input voltage (V<sub>IN</sub> = 3.0 – 5.5Vdc). Their open-frame construction and small footprint enable designers to develop cost- and space-efficient solutions. Standard features include remote On/Off, remote sense, programmable output voltage, over current and over temperature protections.



<sup>\*</sup> UL is a registered trademark of Underwriters Laboratories, Inc.

CSA is a registered trademark of Canadian Standards Association.

<sup>&</sup>lt;sup>‡</sup> VDE is a trademark of Verband Deutscher Elektrotechniker e.V. \*\* ISO is a registered trademark of the International Organization of Standards

## **Absolute Maximum Ratings**

Stresses in excess of the absolute maximum ratings can cause permanent damage to the device. These are absolute stress ratings only, functional operation of the device is not implied at these or any other conditions in excess of those given in the operations sections of the data sheet. Exposure to absolute maximum ratings for extended periods can adversely affect the device reliability.

Parameter	Device	Symbol	Min	Max	Unit
Input Voltage	All	VIN	-0.3	5.8	Vdc
Continuous					
Operating Ambient Temperature	All	TA	-40	85	°C
(see Thermal Considerations section)					
Storage Temperature	All	T <sub>stg</sub>	-55	125	°C

## **Electrical Specifications**

Unless otherwise indicated, specifications apply over all operating input voltage, resistive load, and temperature conditions.

Parameter	Device	Symbol	Min	Тур	Max	Unit
Operating Input Voltage	V <sub>0,set</sub> ≤V <sub>IN</sub> −0.5V	V <sub>IN</sub>	3.0		5.5	Vdc
Maximum Input Current	All	I <sub>IN,max</sub>			10	Adc
(V_{IN}=V_{IN,min}~to~V_{IN,max},~I_{O}{=}I_{O,max}~V_{O,set}=3.3Vdc)						
Input No Load Current	V <sub>O,set</sub> = 0.75Vdc	I <sub>IN,No</sub> load		25		mA
(V_{IN} = 5.0Vdc, I_0 = 0, module enabled)	V <sub>O,set</sub> = 3.3Vdc	I <sub>IN,No load</sub>		30		mA
Input Stand-by Current	All	I <sub>IN,stand-by</sub>		1.5		mA
$(V_{IN} = 5.0Vdc, module disabled)$						
Inrush Transient	All	l²t			0.1	A²s
Input Reflected Ripple Current, peak-to-peak (5Hz to 20MHz, 1 $\mu$ H source impedance; V <sub>IN, min</sub> to V <sub>IN, max</sub> lo= lomax; See Test configuration section)	All			100		mAp-p
Input Ripple Rejection (120Hz)	All			30		dB

CAUTION: This power module is not internally fused. An input line fuse must always be used.

This power module can be used in a wide variety of applications, ranging from simple standalone operation to being part of a complex power architecture. To preserve maximum flexibility, internal fusing is not included, however, to achieve maximum safety and system protection, always use an input line fuse. The safety agencies require a 15A, time-delay fuse (see Safety Considerations section). Based on the information provided in this data sheet on inrush energy and maximum dc input current, the same type of fuse with a lower rating can be used. Refer to the fuse manufacturer's data sheet for further information.

## Electrical Specifications (continued)

GE

Parameter	Device	Symbol	Min	Тур	Max	Unit
Output Voltage Set-point	All	V <sub>O, set</sub>	-2.0	V <sub>O, set</sub>	+2.0	% V <sub>O, set</sub>
(VIN=VIN, min, IO=IO, max, TA=25°C)						
Output Voltage	All	V <sub>O, set</sub>	-3%		+3%	% V <sub>O, set</sub>
(Over all operating input voltage, resistive load, and temperature conditions until end of life)						
Adjustment Range	All	Vo	0.7525		3.63	Vdc
Selected by an external resistor						
Output Regulation						
Line (V <sub>IN</sub> =V <sub>IN, min</sub> to V <sub>IN, max</sub> )	All		—	0.3	—	% V <sub>O, set</sub>
Load (Io=Io, min to Io, max)	All		_	0.4	—	% V <sub>O, set</sub>
Temperature ( $T_{ref}=T_{A, min}$ to $T_{A, max}$ )	All			0.4	_	% V <sub>O, set</sub>
Output Ripple and Noise on nominal output						
(V_{IN}=V_{IN,nom} andI_{O}=I_{O,min} to $I_{O,max}$						
Cout = $1\mu$ F ceramic// $10\mu$ Ftantalum capacitors)						
RMS (5Hz to 20MHz bandwidth)	All		_	8	15	mV <sub>rms</sub>
Peak-to-Peak (5Hz to 20MHz bandwidth)	All			25	50	mV <sub>pk-pk</sub>
External Capacitance						
ESR≥1mΩ	All	C <sub>O, max</sub>	_	—	1000	μF
ESR ≥ 10 mΩ	All	Co, max	_	_	5000	μF
Output Current	All	lo	0		10	Adc
Output Current Limit Inception (Hiccup Mode )	All	I <sub>O, lim</sub>	—	220	_	% 1₀
(V <sub>0</sub> = 90% of V <sub>0, set</sub> )						
Output Short-Circuit Current	All	I <sub>O, s/c</sub>		2		Adc
(V₀≤250mV) ( Hiccup Mode )						
Efficiency	V <sub>0,set</sub> = 0.75Vdc	η		82.5		%
V <sub>IN</sub> = V <sub>IN, nom</sub> , T <sub>A</sub> =25°C	V <sub>0, set</sub> = 1.2Vdc	η		88.0		%
I_O=I_O, max , V_O= V_O,set	V <sub>0,set</sub> = 1.5Vdc	η		89.5		%
	V <sub>0,set</sub> = 1.8Vdc	η		91.0		%
	V <sub>0,set</sub> = 2.5Vdc	η		93.0		%
	V <sub>0,set</sub> = 3.3Vdc	η		95.0		%
Switching Frequency	All	f <sub>sw</sub>		300		kHz
Dynamic Load Response						
$(dIo/dt=2.5A/\mu s; V_{IN} = V_{IN, nom}; T_A=25^{\circ}C)$	All	V <sub>pk</sub>	_	200		mV
Load Change from Io= 50% to 100% of Io,max; 1µF ceramic// 10 µF tantalum						
Peak Deviation						
Settling Time (Vo<10% peak deviation)	All	ts	—	25	_	μs
(dIo/dt=2.5A/µs; V <sub>IN</sub> = V <sub>IN, nom</sub> ; T <sub>A</sub> =25°C)	All	V <sub>pk</sub>	_	200	_	mV
Load Change from Io= 100% to 50% of Io,max: 1µF ceramic// 10 µF tantalum						
Peak Deviation						
Settling Time (Vo<10% peak deviation)	All	ts	—	25	—	μS

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## Electrical Specifications (continued)

Parameter	Device	Symbol	Min	Тур	Max	Unit
Dynamic Load Response						
(dlo/dt=2.5A/ $\mu$ s; V V <sub>IN</sub> = V <sub>IN, nom</sub> ; T <sub>A</sub> =25°C) Load Change from Io= 50% to 100% of Io,max; Co = 2x150 $\mu$ F polymer capacitors Peak Deviation	All	V <sub>pk</sub>		100	_	mV
Settling Time (Vo<10% peak deviation)	All	ts	_	100	_	μs
(dlo/dt=2.5A/ $\mu$ s; V <sub>IN</sub> = V <sub>IN, nom</sub> ; T <sub>A</sub> =25°C) Load Change from lo= 100% to 50% of lo,max: Co = 2x150 $\mu$ F polymer capacitors Peak Deviation	All	V <sub>pk</sub>		100		mV
Settling Time (Vo<10% peak deviation)	All	ts	_	100	_	μS

## **General Specifications**

Parameter	Min	Тур	Max	Unit
Calculated MTBF (Io=Io, max, T_A=25°C)		Hours		
Telecordia SR-332 Issue 1: Method 1 Case 3				
Weight	—	5.6 (0.2)	_	g (oz.)

## **Feature Specifications**

Unless otherwise indicated, specifications apply over all operating input voltage, resistive load, and temperature conditions. See Feature Descriptions for additional information.

Parameter	Device	Symbol	Min	Тур	Max	Unit
On/Off Signal interface						
(On/Off is open collector/drain logic input;						
Signal referenced to GND - See feature description section)						
Input High Voltage (Module ON)	All	VIH	_	_	V <sub>IN, max</sub>	v
Input High Current	All	Ін	_	_	10	μΑ
Input Low Voltage (Module OFF)	All	VIL	-0.2	-	0.3	V
Input Low Current	All	lıı.	_	0.2	1	mA
Turn-On Delay and Rise Times						
(I_0=I_0, max, V_IN=V_IN, nom, T_A = 25 °C)						
Case 1: On/Off input is set to Logic High (Module ON) and then input power is applied (delay from instant at which $V_{IN} = V_{IN, min}$ until Vo=10% of Vo,set)	All	Tdelay	_	3.9	_	msec
Case 2: Input power is applied for at least one second and then the On/Off input is set to logic High (delay from instant at which Von/Off=0.3V until Vo=10% of Vo, set)	All	Tdelay	-	3.9	_	msec
Output voltage Rise time (time for Vo to rise from 10% of Vo,set to 90% of Vo, set)	All	Trise	—	4.2	8.5	msec
Output voltage overshoot – Startup				_	1	% V <sub>O, set</sub>
$I_{0}\text{=}$ $I_{0,\text{ max}}\text{;}$ $V_{\text{IN}}$ = 3.0 to 5.5Vdc, $T_{\text{A}}$ = 25 °C						
Remote Sense Range			-	_	0.5	V
Overtemperature Protection	All	T <sub>ref</sub>		125	_	°C
(See Thermal Consideration section)						
Input Undervoltage Lockout						
Turn-on Threshold	All			2.2		V
Turn-off Threshold	All			2.0		V

## **Characteristic Curves**

The following figures provide typical characteristics for the Austin Lynx<sup>™</sup> SMT modules at 25°C.

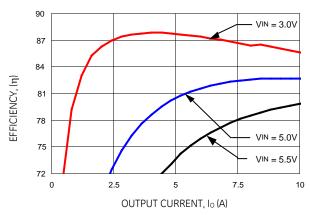


Figure 1. Converter Efficiency versus Output Current (Vout = 0.75Vdc).

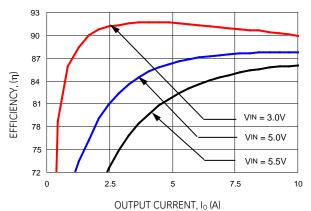


Figure 2. Converter Efficiency versus Output Current (Vout = 1.2Vdc).

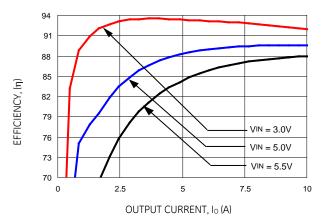


Figure 3. Converter Efficiency versus Output Current (Vout = 1.5Vdc).

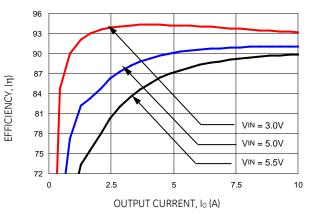
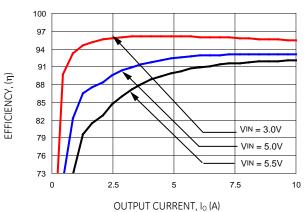
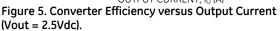


Figure 4. Converter Efficiency versus Output Current (Vout = 1.8Vdc).





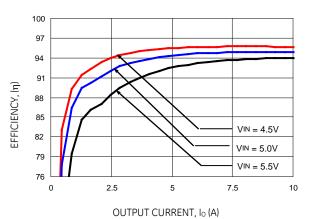
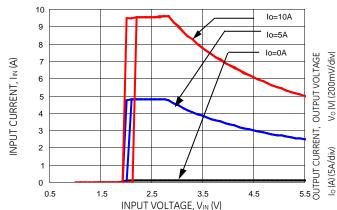


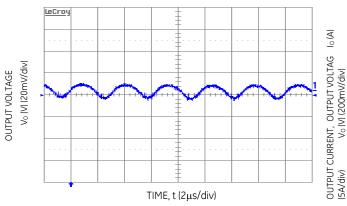
Figure 6. Converter Efficiency versus Output Current (Vout = 3.3Vdc).

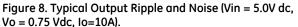
### Characteristic Curves (continued)

The following figures provide typical characteristics for the Austin Lynx<sup>™</sup> SMT modules at 25°C.









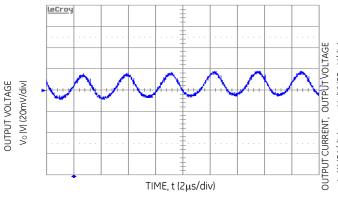
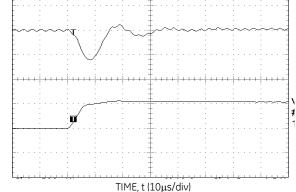
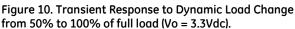


Figure 9. Typical Output Ripple and Noise (Vin = 5.0V dc, Vo = 3.3 Vdc, Io=10A).





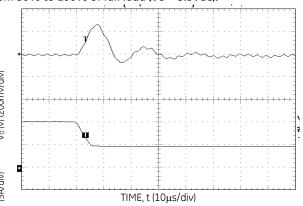


Figure 11. Transient Response to Dynamic Load Change from 100% to 50% of full load (Vo = 3.3 Vdc).

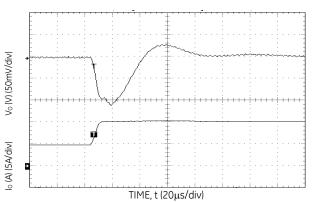


Figure 12. Transient Response to Dynamic Load Change from 50% to 100% of full load (Vo = 3.3 Vdc, Cext =  $2x150 \mu$ F Polymer Capacitors).

## GE

# Austin Lynx<sup>TM</sup>: SMT Non-Isolated DC-DC Power Modules, Programmable 3.0Vdc – 5.5Vdc input; 0.75Vdc to 3.63Vdc output; 10A Output Current

V<sub>o</sub> (V)(1V/div)

Von/off (V) (2V/div)

NPUT VOLTAGE OUTPUT VOLTAGE

V<sub>o</sub> (V)(1V/div)

V<sub>On/off</sub> (V) (2V/div)

### Characteristic Curves (continued)

The following figures provide typical characteristics for the Austin Lynx<sup>™</sup> SMT modules at 25°C.

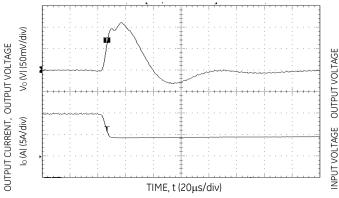


Figure 13. Transient Response to Dynamic Load Change from 100% of 50% full load (Vo = 5.0 Vdc, Cext =  $2x150 \mu$ F Polymer Capacitors).

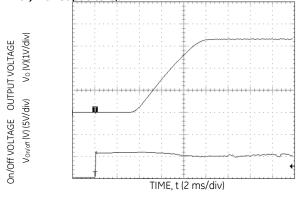


Figure 14. Typical Start-Up Using Remote On/Off (Vin = 5.0Vdc, Vo = 3.3Vdc, Io = 10.0A).

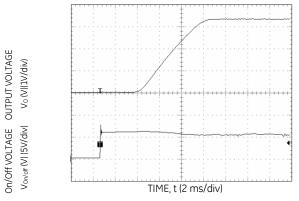


Figure 15. Typical Start-Up Using Remote On/Off with Low-ESR external capacitors (Vin = 5.5Vdc, Vo = 3.3Vdc, Io = 10.0A, Co =  $1050\mu$ F).

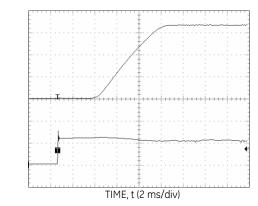
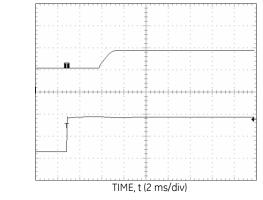
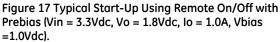
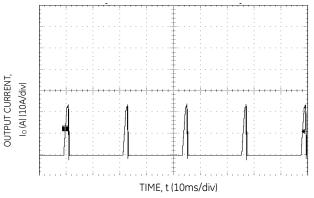
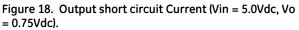


Figure 16. Typical Start-Up with application of Vin (Vin = 5.5Vdc, Vo = 3.3Vdc, Io = 10A).



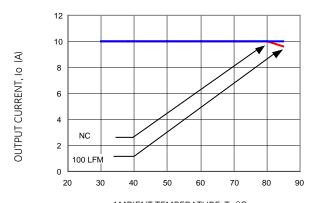






### Characteristic Curves (continued)

The following figures provide thermal derating curves for the Austin Lynx™ SMT modules.



 $\label{eq:ambient temperature, T_A \, ^\circ C} Figure 19. Derating Output Current versus Local Ambient Temperature and Airflow (Vin = 5.0, Vo=0.75Vdc).$ 

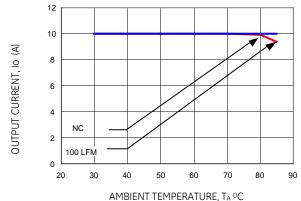


Figure 20. Derating Output Current versus Local Ambient Temperature and Airflow (Vin = 5.0Vdc, Vo=1.8 Vdc).

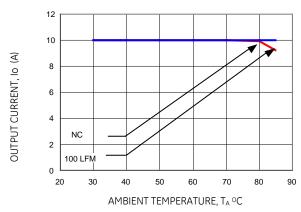
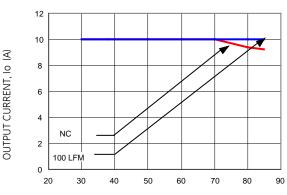
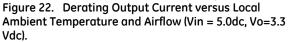


Figure 21. Derating Output Current versus Local Ambient Temperature and Airflow (Vin = 5.0Vdc, Vo=2.5 Vdc).



AMBIENT TEMPERATURE, TA <sup>O</sup>C



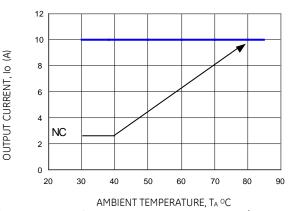
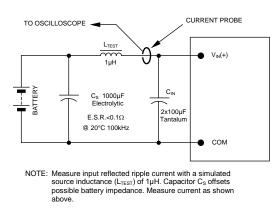
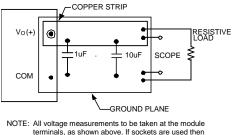


Figure 23. Derating Output Current versus Local Ambient Temperature and Airflow (Vin = 3.3Vdc, Vo=2.5Vdc).

## **Test Configurations**

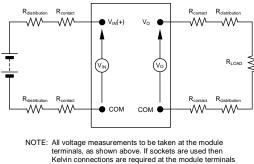


#### Figure 24. Input Reflected Ripple Current Test Setup.



Kelvin connections are required at the module terminals to avoid measurement errors due to socket contact resistance.

Figure 25. Output Ripple and Noise Test Setup.



Kelvin connections are required at the module termina to avoid measurement errors due to socket contact resistance

Figure 26. Output Voltage and Efficiency Test Setup.

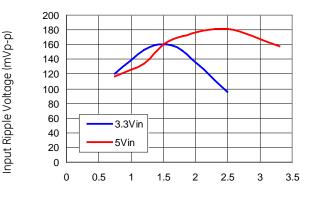
Efficiency 
$$\eta = \frac{V_0. I_0}{V_{IN}. I_{IN}} \times 100 \%$$

### **Design Considerations**

#### Input Filtering

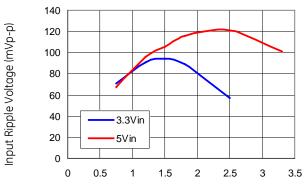
Austin Lynx<sup>™</sup> SMT module should be connected to a lowimpedance source. A highly inductive source can affect the stability of the module. An input capacitance must be placed directly adjacent to the input pin of the module, to minimize input ripple voltage and ensure module stability.

To minimize input voltage ripple, low-ESR polymer and ceramic capacitors are recommended at the input of the module. Figure 27 shows input ripple voltage (mVp-p) for various outputs with 1×150  $\mu$ F polymer capacitors (Panasonic p/n: EEFUE0J151R, Sanyo p/n: 6TPE150M) in parallel with 1 × 47  $\mu$ F ceramic capacitor (Panasonic p/n: ECJ-5YB0J476M, Taiyo-Yuden p/n: CEJMK432BJ476MMT) at full load. Figure 28 shows the input ripple with 2×150  $\mu$ F polymer capacitors in parallel with 2 × 47  $\mu$ F ceramic capacitor at full load.



#### Output Voltage (Vdc)

Figure 27. Input ripple voltage for various output with 1x150  $\mu F$  polymer and 1x47  $\mu F$  ceramic capacitors at the input (full load).



#### Output Voltage (Vdc)

Figure 28. Input ripple voltage for various output with 2x150  $\mu F$  polymer and 2x47  $\mu F$  ceramic capacitors at the input (full load).

### Design Considerations (continued)

### **Output Filtering**

The Austin Lynx<sup>TM</sup> SMT module is designed for low output ripple voltage and will meet the maximum output ripple specification with 1  $\mu$ F ceramic and 10  $\mu$ F tantalum capacitors at the output of the module. However, additional output filtering may be required by the system designer for a number of reasons. First, there may be a need to further reduce the output ripple and noise of the module. Second, the dynamic response characteristics may need to be customized to a particular load step change.

To reduce the output ripple and improve the dynamic response to a step load change, additional capacitance at the output can be used. Low ESR polymer and ceramic capacitors are recommended to improve the dynamic response of the module. For stable operation of the module, limit the capacitance to less than the maximum output capacitance as specified in the electrical specification table.

### **Safety Considerations**

For safety agency approval the power module must be installed in compliance with the spacing and separation requirements of the end-use safety agency standards, i.e., UL 60950-1, CSA C22.2 No. 60950-1-03, and VDE 0850:2001-12 (EN60950-1) Licensed.

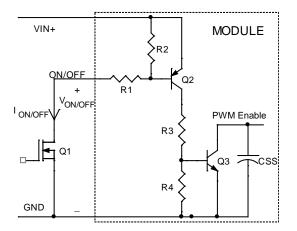
For the converter output to be considered meeting the requirements of safety extra-low voltage (SELV), the input must meet SELV requirements. The power module has extra-low voltage (ELV) outputs when all inputs are ELV.

The input to these units is to be provided with a fast-acting fuse with a maximum rating of 15A in the positive input lead.

### **Feature Description**

### Remote On/Off

The Austin Lynx<sup>TM</sup> SMT power modules feature an On/Off pin for remote On/Off operation. The On/Off pin is an open collector/drain logic input signal (Von/Off) that is referenced to ground. Circuit configuration for using the On/Off pin is shown in Figure 29. During a logic-high (On/Off pin is pulled high internal to the module) when the transistor Q1 is in the Off state, the power module is ON. Maximum allowable leakage current of the transistor when Von/off = V<sub>IN,max</sub> is 10µA. Applying a logic-low when the transistor Q1 is turned-On, the power module is OFF. During this state VOn/Off must be less than 0.3V. When not using positive logic On/off pin, leave the pin unconnected or tie to V<sub>IN</sub>.

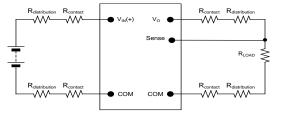


## Figure 29. Circuit configuration for using positive logic On/OFF.

#### **Remote Sense**

The Austin Lynx<sup>™</sup> SMT power modules offer an option for Remote Sense feature. When the device code description includes a suffix "3", sense pin is added to the module and the Remote Sense feature is active. See ordering information at the end of this document for code description.

Remote sense minimizes the effects of distribution losses by regulating the voltage at the load via Sense and GND pins (see Figure 30). The voltage between the Sense pin and Vo pin must not exceed 0.5V. The amount of power delivered by the module is defined as the output voltage multiplied by the output current (Vo x Io). When using Remote Sense, the output voltage of the module can increase, which if the same output is maintained, increases the power output by the module. Make sure that the maximum output power of the module remains at or below the maximum rated power. When the Remote Sense feature is not being used, tie the Sense pin to output pin.



## Figure 32. Remote sense circuit configuration.

### **Overcurrent Protection**

To provide protection in a fault (output overload) condition, the unit is equipped with internal current-limiting circuitry and can endure current limiting continuously. At the point of current-limit inception, the unit enters hiccup mode. The unit operates normally once the output current is brought back into its specified range. The typical average output current during hiccup is 3A.

#### Input Undervoltage Lockout

At input voltages below the input undervoltage lockout limit, module operation is disabled. The module will begin to operate at an input voltage above the undervoltage lockout turn-on threshold.

#### **Overtemperature Protection**

To provide protection in a fault condition, the unit is equipped with a thermal shutdown circuit. The unit will shutdown if the thermal reference point  $T_{ref}$ , exceeds 125°C (typical), but the thermal shutdown is not intended as a guarantee that the unit will survive temperatures beyond its rating. The module will automatically restarts after it cools down.

### **Output Voltage Programming**

The output voltage of the Austin Lynx<sup>™</sup> SMT can be programmed to any voltage from 0.75 Vdc to 3.63 Vdc by connecting a single resistor (shown as Rtrim in Figure 31) between the TRIM and GND pins of the module. Without an external resistor between the TRIM pin and the ground, the output voltage of the module is 0.7525 Vdc. To calculate the value of the resistor *Rtrim* for a particular output voltage Vo, use the following equation:

$$Rtrim = \left[\frac{21070}{Vo - 0.7525} - 5110\right]\Omega$$

For example, to program the output voltage of the Austin Lynx™ II module to 1.8 Vdc, *Rtrim* is calculated is follows:

$$Rtrim = \left[\frac{21070}{1.8 - 0.7525} - 5110\right]\Omega$$

$$Rtrim = 15.004k\Omega$$

### Feature Descriptions (continued)

GF

### Output Voltage Programming (continued)

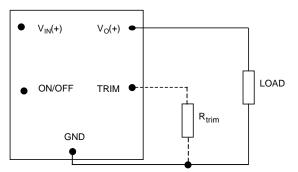


Figure 31. Circuit configuration for programming output voltage using an external resistor.

Table 1 provides *Rtrim* values required for some common output voltages.

### Table 1

Vo, (V)	Rtrim (KΩ)
0.7525	Open
1.2	41.973
1.5	23.077
1.8	15.004
2.5	6.947
3.3	3.160

By a using 1% tolerance trim resistor, set point tolerance of  $\pm 2\%$  is achieved as specified in the electrical specification. The POL Programming Tool, available at www.gecriticalpower.com under the Design Tools section, helps determine the required external trim resistor needed for a specific output voltage.

The amount of power delivered by the module is defined as the voltage at the output terminals multiplied by the output current. When using the trim feature, the output voltage of the module can be increased, which at the same output current would increase the power output of the module. Care should be taken to ensure that the maximum output power of the module remains at or below the maximum rated power ( $P_{max} = V_{o,set} \times I_{o,max}$ ).

### **Voltage Margining**

Output voltage margining can be implemented in the Austin Lynx<sup>™</sup> modules by connecting a resistor, R<sub>margin-up</sub>, from the Trim pin to the ground pin for margining-up the output voltage and by connecting a resistor, R<sub>margin-down</sub>, from the Trim pin to the Output pin for margining-down. Figure 32 shows the circuit configuration for output voltage margining. The POL Programming Tool, available at www.gecriticalpower.com under the Design Tools section, also calculates the values of  $R_{margin-up}$  and  $R_{margin-down}$  for a specific output voltage and % margin. Please consult your local GE technical representative for additional details.

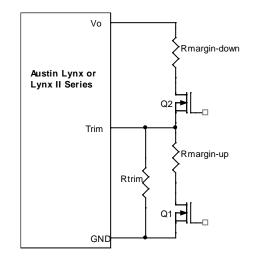


Figure 32. Circuit Configuration for margining Output voltage.

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# Austin Lynx<sup>TM</sup>: SMT Non-Isolated DC-DC Power Modules, Programmable 3.0Vdc – 5.5Vdc input; 0.75Vdc to 3.63Vdc output; 10A Output Current

## **Thermal Considerations**

The power modules operate in a variety of thermal environments; however, sufficient cooling should always be provided to help ensure reliable operation.

Considerations include ambient temperature, airflow, module power dissipation, and the need for increased reliability. A reduction in the operating temperature of the module will result in an increase in reliability. The thermal data presented here is based on physical measurements taken in a wind tunnel. The test set-up is shown in Figure 34. Note that the airflow is parallel to the long axis of the module as shown in figure 33. The derating data applies to airflow in either direction of the module's long axis.

Top View

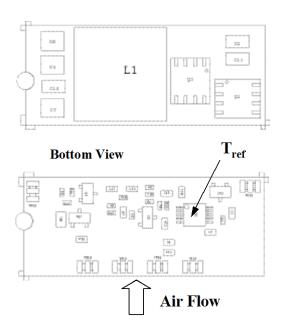


Figure 33. Tref Temperature measurement location.

25.4\_ Wind Tunnel (1.0)**PWBs** PowerModule 76.2 (3.0) Probe Location for measuring 8.3 airflow and (0.325)ambient temperature October 7, 2015 ©2015 General Electric Company. All rights reserved. Air flow

The thermal reference point,  $T_{ref}$  used in the specifications is shown in Figure 33. For reliable operation this temperature

should not exceed 115 °C.

The output power of the module should not exceed the rated power of the module (Vo,set  $\times$  Io,max).

Please refer to the Application Note "Thermal Characterization Process For Open-Frame Board-Mounted Power Modules" for a detailed discussion of thermal aspects including maximum device temperatures.

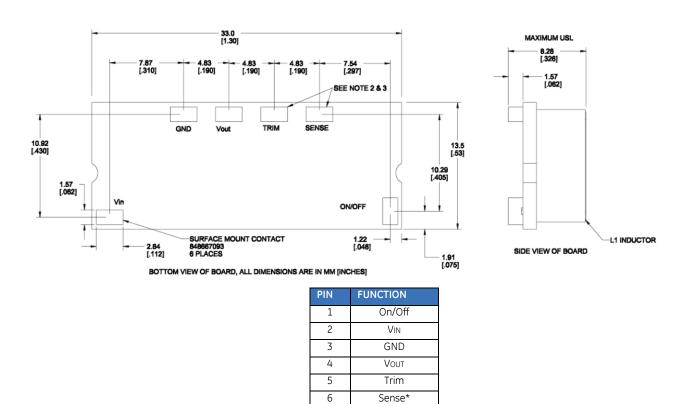
#### Figure 34. Thermal Test Set-up.

### Heat Transfer via Convection

Increased airflow over the module enhances the heat transfer via convection. Thermal derating curves showing the maximum output current that can be delivered at different local ambient temperature ( $T_A$ ) for airflow conditions ranging from natural convection and up to 2m/s (400 ft./min) are shown in the Characteristics Curves section.

## **Mechanical Outline**

Dimensions are in millimeters and (inches). Tolerances: x.x mm  $\pm$  0.5 mm (x.xx in.  $\pm$  0.02 in.) [unless otherwise indicated] x.xx mm  $\pm$  0.25 mm (x.xxx in  $\pm$  0.010 in.)



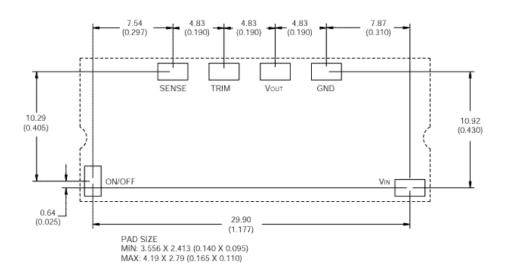
\* Remote sense feature is a customer specified option (code suffix "3")

## **Recommended Pad Layout**

### Dimensions are in millimeters and (inches).

Tolerances: x.x mm  $\pm$  0.5 mm (x.xx in.  $\pm$  0.02 in.) [unless otherwise indicated]

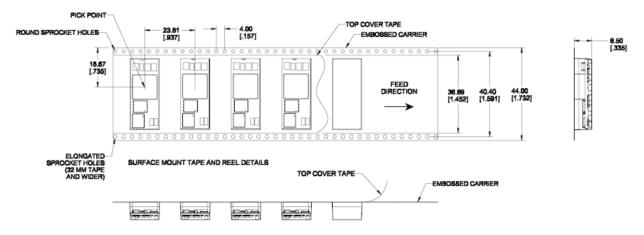
x.xx mm  $\pm$  0.25 mm (x.xxx in  $\pm$  0.010 in.)



PIN	FUNCTION
1	On/Off
2	Vin
3	GND
4	Vout
5	Trim
6	Sense*

## **Packaging Details**

The Austin Lynx<sup>TM</sup> SMT version is supplied in tape & reel as standard. Modules are shipped in quantities of 400 modules per reel.



NOTE: CONFORMS TO EAI-481 REV. A STANDARD

All Dimensions are in millimeters and (in inches).

### **Reel Dimensions**

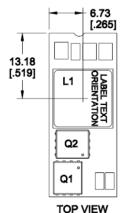
Outside diameter:	330.2 mm (13.00)
Inside diameter:	177.8 mm (7.00")
Tape Width:	44.0 mm (1.73")

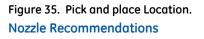
## **Surface Mount Information**

### **Pick and Place**

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The Austin Lynx<sup>™</sup> SMT modules use an open frame construction and are designed for a fully automated assembly process. The modules are fitted with a label designed to provide a large surface area for pick and place operations. The label meets all the requirements for surface mount processing, as well as safety standards, and is able to withstand reflow temperatures of up to 300°C. The label also carries product information such as product code, serial number and location of manufacture.



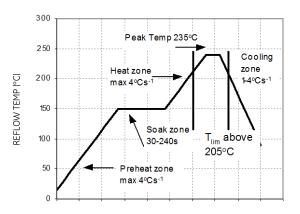


The module weight has been kept to a minimum by using open frame construction. Even so, these modules have a relatively large mass when compared to conventional SMT components. Variables such as nozzle size, tip style, vacuum pressure and pick & placement speed should be considered to optimize this process. The minimum recommended nozzle diameter for reliable operation is 3mm. The maximum nozzle outer diameter, which will safely fit within the allowable component spacing, is 12 mm max.

### **Tin Lead Soldering**

The Austin Lynx<sup>™</sup> SMT power modules are lead free modules and can be soldered either in a lead-free solder process or in a conventional Tin/Lead (Sn/Pb) process. It is recommended that the customer review data sheets in order to customize the solder reflow profile for each application board assembly. The following instructions must be observed when soldering these units. Failure to observe these instructions may result in the failure of or cause damage to the modules, and can adversely affect long-term reliability.

In a conventional Tin/Lead (Sn/Pb) solder process peak reflow temperatures are limited to less than 235°C. Typically, the eutectic solder melts at 183°C, wets the land, and subsequently wicks the device connection. Sufficient time must be allowed to fuse the plating on the connection to ensure a reliable solder joint. There are several types of SMT reflow technologies currently used in the industry. These surface mount power modules can be reliably soldered using natural forced convection, IR (radiant infrared), or a combination of convection/IR. For reliable soldering the solder reflow profile should be established by accurately measuring the modules CP connector temperatures.



REFLOW TIME (S) Figure 35. Reflow Profile for Tin/Lead (Sn/Pb) process.

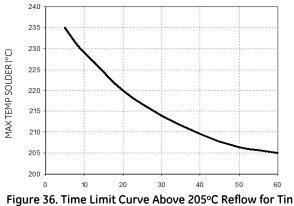


Figure 36. Time Limit Curve Above 205°C Reflow for Tin Lead (Sn/Pb) process.

## GE

# Austin Lynx<sup>TM</sup>: SMT Non-Isolated DC-DC Power Modules, Programmable 3.0Vdc – 5.5Vdc input; 0.75Vdc to 3.63Vdc output; 10A Output Current

## Surface Mount Information (continued)

### Lead Free Soldering

The –Z version Austin Lynx Programmable SMT modules are lead-free (Pb-free) and RoHS compliant and are both forward and backward compatible in a Pb-free and a SnPb soldering process. Failure to observe the instructions below may result in the failure of or cause damage to the modules and can adversely affect long-term reliability.

### **Pb-free Reflow Profile**

Power Systems will comply with J-STD-020 Rev. C (Moisture/Reflow Sensitivity Classification for Nonhermetic Solid State Surface Mount Devices) for both Pb-free solder profiles and MSL classification procedures. This standard provides a recommended forced-air-convection reflow profile based on the volume and thickness of the package (table 4-2). The suggested Pb-free solder paste is Sn/Ag/Cu (SAC). The recommended linear reflow profile using Sn/Ag/Cu solder is shown in Figure. 37.

### **MSL Rating**

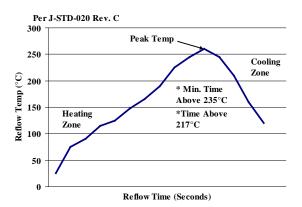
The Austin Lynx Programmable SMT modules have a MSL rating of 2a.

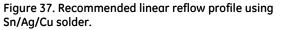
### Storage and Handling

The recommended storage environment and handling procedures for moisture-sensitive surface mount packages is detailed in J-STD-033 Rev. A (Handling, Packing, Shipping and Use of Moisture/Reflow Sensitive Surface Mount Devices). Moisture barrier bags (MBB) with desiccant are required for MSL ratings of 2 or greater. These sealed packages should not be broken until time of use. Once the original package is broken, the floor life of the product at conditions of <= 30°C and 60% relative humidity varies according to the MSL rating (see J-STD-033A). The shelf life for dry packed SMT packages will be a minimum of 12 months from the bag seal date, when stored at the following conditions: < 40° C, < 90% relative humidity.

### Post Solder Cleaning and Drying Considerations

Post solder cleaning is usually the final circuit-board assembly process prior to electrical board testing. The result of inadequate cleaning and drying can affect both the reliability of a power module and the testability of the finished circuit-board assembly. For guidance on appropriate soldering, cleaning and drying procedures, refer to *Board Mounted Power Modules: Soldering and Cleaning* Application Note (AN04-001).





## **Ordering Information**

Please contact your GE Sales Representative for pricing, availability and optional features. **Table 2. Device Codes** 

Device Code	Input Voltage Range	Output Voltage	Output Current	Efficiency 3.3V@ 10A	Connector Type	Comcodes
AXH010A0X-SR	3.0 – 5.5Vdc	0.75 – 3.63Vdc	10 A	95.0%	SMT	108992021
AXH010A0X-SRZ	3.0 – 5.5Vdc	0.75 – 3.63Vdc	10 A	95.0%	SMT	CC109104948
AXH010A0X3-SR*	3.0 – 5.5Vdc	0.75 – 3.63Vdc	10 A	95.0%	SMT	108992038
AXH010A0X3-SRZ*	3.0 – 5.5Vdc	0.75 – 3.63Vdc	10 A	95.0%	SMT	CC109104931

\* Remote sense feature is active and pin 6 is added with code suffix "3"

\* -Z refers to RoHS-compliant versions.

## Contact Us

For more information, call us at

USA/Canada: +1 877 546 3243, or +1 972 244 9288

Asia-Pacific: +86.021.54279977\*808

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CA-17205-L4

PROPOWER-3.3V
MYGTM01210BZN
JRCS016A0S4-HZ
3V12-N0.8
6AA24-P30-I5-M
BM2P101X-Z
ROF-78E12-0.5SMD-R

RPMA5.0-8.0/OF
RPX-4.0-CT
PTV03010WAD
PTV05020WAH
PTV12010LAH
PTV12020WAD
R-7212D
R-7212P
R-78AA5.0 

1.0SMD
30A24-N15-E
10A12-P4-M
10C24-N250-I5
10C24-P125
10C24-P250-I5
6A24-P20-I10-F-M-25PPM
1A24-P30-F-M-C
TSR 1 

24150SM
1/2AA24-N30-I10
1C24-N125
12C24-N250
V7806-1500
PTV12020LAH
PTV05010WAH
PTN04050CAZT
PTH12020WAD

PTH12020LAS
PTH05T210WAH
PTH05030WAZ
V7803-2000R
AXA005A0XZ
NSR020A0X43Z
TPS82677SIPR
OKR-T/30-W12-C

NID30S24-15
NID30S48-24
LXDC2HL25A-053
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